



Welcome to [E-XFL.COM](https://www.e-xfl.com)

### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

|                                |                                                                                                                                                                 |
|--------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Product Status                 | Obsolete                                                                                                                                                        |
| Number of LABs/CLBs            | -                                                                                                                                                               |
| Number of Logic Elements/Cells | -                                                                                                                                                               |
| Total RAM Bits                 | -                                                                                                                                                               |
| Number of I/O                  | 101                                                                                                                                                             |
| Number of Gates                | 14000                                                                                                                                                           |
| Voltage - Supply               | 3V ~ 3.6V, 4.5V ~ 5.5V                                                                                                                                          |
| Mounting Type                  | Surface Mount                                                                                                                                                   |
| Operating Temperature          | -40°C ~ 85°C (TA)                                                                                                                                               |
| Package / Case                 | 160-BQFP                                                                                                                                                        |
| Supplier Device Package        | 160-PQFP (28x28)                                                                                                                                                |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/microchip-technology/a42mx09-pq160i">https://www.e-xfl.com/product-detail/microchip-technology/a42mx09-pq160i</a> |

# Contents

---

|        |                                                         |    |
|--------|---------------------------------------------------------|----|
| 1      | Revision History                                        | 1  |
| 1.1    | Revision 15.0                                           | 1  |
| 1.2    | Revision 14.0                                           | 1  |
| 1.3    | Revision 13.0                                           | 1  |
| 1.4    | Revision 12.0                                           | 1  |
| 1.5    | Revision 11.0                                           | 1  |
| 1.6    | Revision 10.0                                           | 1  |
| 1.7    | Revision 9.0                                            | 2  |
| 1.8    | Revision 6.0                                            | 2  |
| 2      | 40MX and 42MX FPGA Families                             | 1  |
| 2.1    | Features                                                | 1  |
| 2.1.1  | High Capacity                                           | 1  |
| 2.1.2  | High Performance                                        | 1  |
| 2.1.3  | HiRel Features                                          | 1  |
| 2.1.4  | Ease of Integration                                     | 1  |
| 2.2    | Product Profile                                         | 1  |
| 2.3    | Ordering Information                                    | 3  |
| 2.4    | Plastic Device Resources                                | 4  |
| 2.5    | Ceramic Device Resources                                | 4  |
| 2.6    | Temperature Grade Offerings                             | 5  |
| 2.7    | Speed Grade Offerings                                   | 5  |
| 3      | 40MX and 42MX FPGAs                                     | 6  |
| 3.1    | General Description                                     | 6  |
| 3.2    | MX Architectural Overview                               | 6  |
| 3.2.1  | Logic Modules                                           | 6  |
| 3.2.2  | Dual-Port SRAM Modules                                  | 8  |
| 3.2.3  | Routing Structure                                       | 9  |
| 3.2.4  | Clock Networks                                          | 10 |
| 3.2.5  | MultiPlex I/O Modules                                   | 11 |
| 3.3    | Other Architectural Features                            | 12 |
| 3.3.1  | Performance                                             | 12 |
| 3.3.2  | User Security                                           | 12 |
| 3.3.3  | Programming                                             | 12 |
| 3.3.4  | Power Supply                                            | 13 |
| 3.3.5  | Power-Up/Down in Mixed-Voltage Mode                     | 13 |
| 3.3.6  | Transient Current                                       | 13 |
| 3.3.7  | Low Power Mode                                          | 14 |
| 3.4    | Power Dissipation                                       | 14 |
| 3.4.1  | General Power Equation                                  | 14 |
| 3.4.2  | Static Power Component                                  | 14 |
| 3.4.3  | Active Power Component                                  | 14 |
| 3.4.4  | Equivalent Capacitance                                  | 15 |
| 3.4.5  | C <sub>EQ</sub> Values for Microsemi MX FPGAs           | 15 |
| 3.4.6  | Test Circuitry and Silicon Explorer II Probe            | 16 |
| 3.4.7  | Design Consideration                                    | 17 |
| 3.4.8  | IEEE Standard 1149.1 Boundary Scan Test (BST) Circuitry | 17 |
| 3.4.9  | JTAG Mode Activation                                    | 19 |
| 3.4.10 | TRST Pin and TAP Controller Reset                       | 19 |

Figure 51 BG272 ..... 145

Figure 52 PG132 ..... 153

Figure 53 CQ172 ..... 158

# 1 Revision History

---

The revision history describes the changes that were implemented in the document. The changes are listed by revision, starting with the most current publication.

## 1.1 Revision 15.0

The following is a summary of the changes in revision 15.0 of this document.

- Table 15, page 21 is edited to add the footnote,  $V_{IH}(\text{Min})$  is 2.4V for A42MX36 family. This applies only to VCCI of 5V and is not applicable to VCCI of 3.3V
- Table 22, page 25 is edited to add the footnote,  $V_{IH}(\text{Min})$  is 2.4V for A42MX36 family. This applies only to VCCI of 5V and is not applicable to VCCI of 3.3V
- Table 23, page 25 is edited to add the footnote,  $V_{IH}(\text{Min})$  is 2.4V for A42MX36 family. This applies only to VCCI of 5V and is not applicable to VCCI of 3.3V

## 1.2 Revision 14.0

The following is a summary of the changes in revision 14.0 of this document.

- Added CQFP package information for A42MX16 device in Product Profile, page 1 and Ceramic Device Resources, page 4 (SAR 79522).
- Added Military (M) and MIL-STD-883 Class B (B) grades for CPGA 132 Package and added Commercial (C), Military (M), and MIL-STD-883 Class B (B) grades for CQFP 172 Package in Temperature Grade Offerings, page 5 (SAR 79519)
- Changed Silicon Sculptor II to Silicon Sculptor in Programming, page 12 (SAR 38754)
- Added Figure 53, page 158 CQ172 package (SAR 79522).

## 1.3 Revision 13.0

The following is a summary of the changes in revision 13.0 of this document.

- Added Figure 42, page 97 PQ144 Package for A42MX09 device (SAR 69776)
- Added Figure 52, page 153 PQ132 Package for A42MX09 device (SAR 69776)

## 1.4 Revision 12.0

The following is a summary of the changes in revision 12.0 of this document.

- Added information on power-up behavior for A42MX24 and A42MX36 devices to the Power Supply, page 13 (SAR 42096)
- Corrected the inadvertent mistake in the naming of the PL68 pin assignment table (SARs 48999, 49793)

## 1.5 Revision 11.0

The following is a summary of the changes in revision 11.0 of this document.

- The FuseLock logo and accompanying text was removed from the User Security, page 12. This marking is no longer used on Microsemi devices (PCN 0915)
- The Development Tool Support, page 19 was updated (SAR 38512)

## 1.6 Revision 10.0

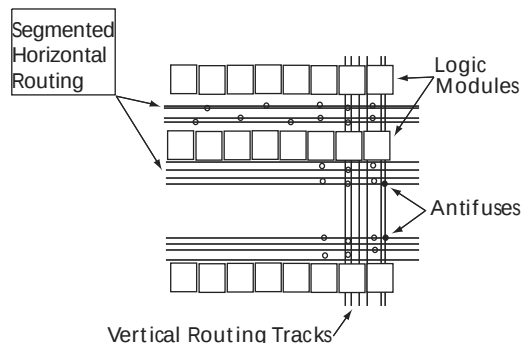
The following is a summary of the changes in revision 10.0 of this document.

- Ordering Information, page 3 was updated to include lead-free package ordering codes (SAR 21968)
- The User Security, page 12 was revised to clarify that although no existing security measures can give an absolute guarantee, Microsemi FPGAs implement the best security available in the industry (SAR 34673)

### 3.2.3.3 Antifuse Structures

An antifuse is a “normally open” structure. The use of antifuses to implement a programmable logic device results in highly testable structures as well as efficient programming algorithms. There are no pre-existing connections; temporary connections can be made using pass transistors. These temporary connections can isolate individual antifuses to be programmed and individual circuit structures to be tested, which can be done before and after programming. For instance, all metal tracks can be tested for continuity and shorts between adjacent tracks, and the functionality of all logic modules can be verified.

**Figure 7 • MX Routing Structure**



### 3.2.4 Clock Networks

The 40MX devices have one global clock distribution network (CLK). A signal can be put on the CLK network by being routed through the CLKBUF buffer.

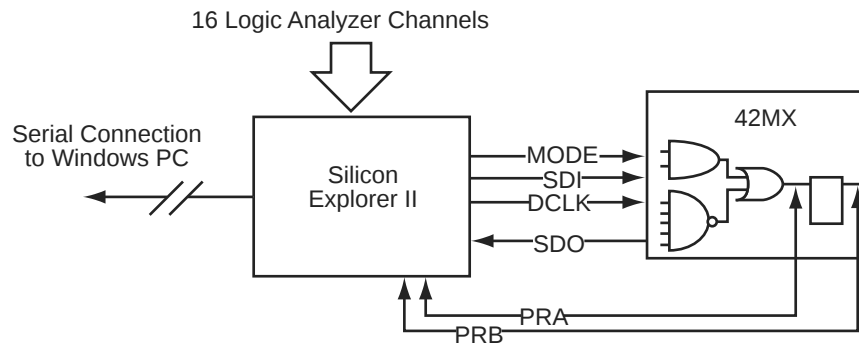
In 42MX devices, there are two low-skew, high-fanout clock distribution networks, referred to as CLKA and CLKB. Each network has a clock module (CLKMOD) that can select the source of the clock signal from any of the following (Figure 8, page 11):

- Externally from the CLKA pad, using CLKBUF buffer
- Externally from the CLKB pad, using CLKBUF buffer
- Internally from the CLKINTA input, using CLKINT buffer
- Internally from the CLKINTB input, using CLKINT buffer

The clock modules are located in the top row of I/O modules. Clock drivers and a dedicated horizontal clock track are located in each horizontal routing channel.

Clock input pads in both 40MX and 42MX devices can also be used as normal I/Os, bypassing the clock networks.

The A42MX36 device has four additional register control resources, called quadrant clock networks (Figure 9, page 11). Each quadrant clock provides a local, high-fanout resource to the contiguous logic modules within its quadrant of the device. Quadrant clock signals can originate from specific I/O pins or from the internal array and can be used as a secondary register clock, register clear, or output enable.

**Figure 13 • Silicon Explorer II Setup with 42MX****Table 8 • Device Configuration Options for Probe Capability**

| Security Fuse(s) Programmed | Mode | PRA, PRB <sup>1</sup>  | SDI, SDO, DCLK <sup>1</sup> |
|-----------------------------|------|------------------------|-----------------------------|
| No                          | LOW  | User I/Os <sup>2</sup> | User I/Os <sup>2</sup>      |
| No                          | HIGH | Probe Circuit Outputs  | Probe Circuit Inputs        |
| Yes                         | –    | Probe Circuit Secured  | Probe Circuit Secured       |

1. Avoid using SDI, SDO, DCLK, PRA and PRB pins as input or bidirectional ports. Since these pins are active during probing, input signals will not pass through these pins and may cause contention.
2. If no user signal is assigned to these pins, they will behave as unused I/Os in this mode. See the Pin Descriptions, page 83 for information on unused I/O pins

### 3.4.7 Design Consideration

It is recommended to use a series 70Ω termination resistor on every probe connector (SDI, SDO, MODE, DCLK, PRA and PRB). The 70 Ω series termination is used to prevent data transmission corruption during probing and reading back the checksum.

### 3.4.8 IEEE Standard 1149.1 Boundary Scan Test (BST) Circuitry

42MX24 and 42MX36 devices are compatible with IEEE Standard 1149.1 (informally known as Joint Testing Action Group Standard or JTAG), which defines a set of hardware architecture and mechanisms for cost-effective board-level testing. The basic MX boundary-scan logic circuit is composed of the TAP (test access port), TAP controller, test data registers and instruction register (Figure 14, page 18). This circuit supports all mandatory IEEE 1149.1 instructions (EXTEST, SAMPLE/PRELOAD and BYPASS) and some optional instructions. Table 9, page 18 describes the ports that control JTAG testing, while Table 10, page 18 describes the test instructions supported by these MX devices.

Each test section is accessed through the TAP, which has four associated pins: TCK (test clock input), TDI and TDO (test data input and output), and TMS (test mode selector).

The TAP controller is a four-bit state machine. The '1's and '0's represent the values that must be present at TMS at a rising edge of TCK for the given state transition to occur. IR and DR indicate that the instruction register or the data register is operating in that state.

The TAP controller receives two control inputs (TMS and TCK) and generates control and clock signals for the rest of the test logic architecture. On power-up, the TAP controller enters the Test-Logic-Reset state. To guarantee a reset of the controller from any of the possible states, TMS must remain high for five TCK cycles.

42MX24 and 42MX36 devices support three types of test data registers: bypass, device identification, and boundary scan. The bypass register is selected when no other register needs to be accessed in a device. This speeds up test data transfer to other devices in a test data path. The 32-bit device identification register is a shift register with four fields (lowest significant byte (LSB), ID number, part number and version). The boundary-scan register observes and controls the state of each I/O pin.

3. All outputs unloaded. All inputs = VCC/VCCI or GND

## 3.8 3.3 V Operating Conditions

The following table shows 3.3 V operating conditions.

**Table 16 • Absolute Maximum Ratings for 40MX Devices\***

| Symbol           | Parameter           | Limits            | Units |
|------------------|---------------------|-------------------|-------|
| VCC              | DC Supply Voltage   | –0.5 to +7.0      | V     |
| VI               | Input Voltage       | –0.5 to VCC + 0.5 | V     |
| VO               | Output Voltage      | –0.5 to VCC + 0.5 | V     |
| t <sub>STG</sub> | Storage Temperature | –65 to +150       | °C    |

**Note:** \*Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. Exposure to absolute maximum rated conditions for extended periods may affect device reliability. Devices should not be operated outside the recommended operating conditions.

**Table 17 • Absolute Maximum Ratings for 42MX Devices\***

| Symbol           | Parameter                   | Limits           | Units |
|------------------|-----------------------------|------------------|-------|
| VCCI             | DC Supply Voltage for I/Os  | –0.5 to +7.0     | V     |
| VCCA             | DC Supply Voltage for Array | –0.5 to +7.0     | V     |
| VI               | Input Voltage               | –0.5 to VCCI+0.5 | V     |
| VO               | Output Voltage              | –0.5 to VCCI+0.5 | V     |
| t <sub>STG</sub> | Storage Temperature         | –65 to +150      | °C    |

**Note:** \*Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. Exposure to absolute maximum rated conditions for extended periods may affect device reliability. Devices should not be operated outside the recommended operating conditions.

**Table 18 • Recommended Operating Conditions**

| Parameter          | Commercial | Industrial | Military    | Units |
|--------------------|------------|------------|-------------|-------|
| Temperature Range* | 0 to +70   | –40 to +85 | –55 to +125 | °C    |
| VCC (40MX)         | 3.0 to 3.6 | 3.0 to 3.6 | 3.0 to 3.6  | V     |
| VCCA (42MX)        | 3.0 to 3.6 | 3.0 to 3.6 | 3.0 to 3.6  | V     |
| VCCI (42MX)        | 3.0 to 3.6 | 3.0 to 3.6 | 3.0 to 3.6  | V     |

**Note:** \*Ambient temperature (T<sub>A</sub>) is used for commercial and industrial grades; case temperature (T<sub>C</sub>) is used for military grades.

All the following tables show various specifications and operating conditions of 40MX and 42MX FPGAs.

**Table 23 • DC Specification (5.0 V PCI Signaling)<sup>1</sup>**

| Symbol           | Parameter             | Condition | PCI  |      | MX   |                     | Units |
|------------------|-----------------------|-----------|------|------|------|---------------------|-------|
|                  |                       |           | Min. | Max. | Min. | Max.                |       |
| C <sub>IN</sub>  | Input Pin Capacitance |           |      | 10   | —    | 10                  | pF    |
| C <sub>CLK</sub> | CLK Pin Capacitance   |           | 5    | 12   | —    | 10                  | pF    |
| L <sub>PIN</sub> | Pin Inductance        |           |      | 20   | —    | < 8 nH <sup>4</sup> | nH    |

1. PCI Local Bus Specification, Version 2.1, Section 4.2.1.1.

2. Maximum rating for VCCI –0.5 V to 7.0 V

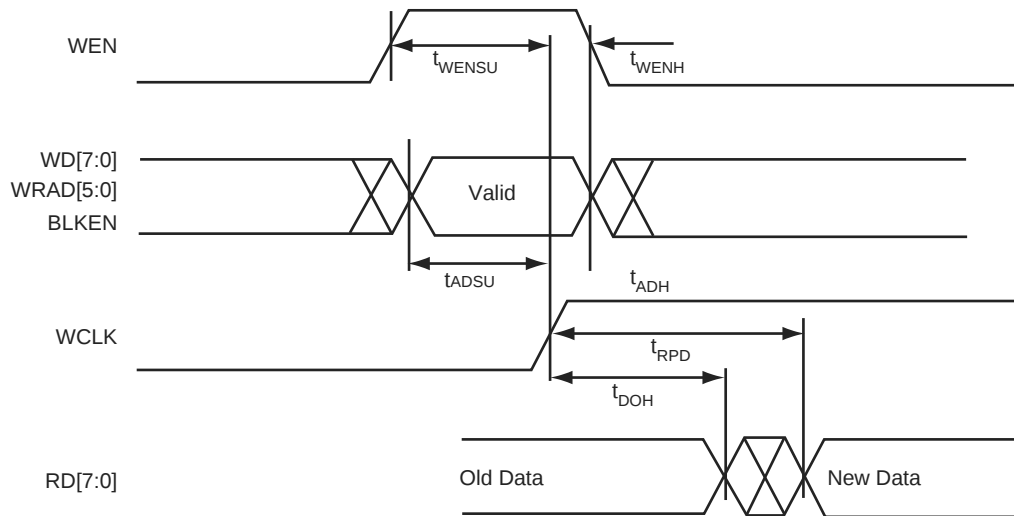
3. VIH(Min) is 2.4V for A42MX36 family. This applies only to VCCI of 5V and is not applicable to VCCI of 3.3V.

4. Dependent upon the chosen package. PCI recommends QFP and BGA packaging to reduce pin inductance and capacitance.

**Table 24 • AC Specifications (5.0V PCI Signaling)\***

| Symbol   | Parameter             | Condition             | PCI                          |      | MX   |      | Units |
|----------|-----------------------|-----------------------|------------------------------|------|------|------|-------|
|          |                       |                       | Min.                         | Max. | Min. | Max. |       |
| ICL      | Low Clamp Current     | $-5 < V_{IN} \leq -1$ | $-25 + (V_{IN} + 1) / 0.015$ |      | –60  | –10  | mA    |
| Slew (r) | Output Rise Slew Rate | 0.4 V to 2.4 V load   | 1                            | 5    | 1.8  | 2.8  | V/ns  |
| Slew (f) | Output Fall Slew Rate | 2.4 V to 0.4 V load   | 1                            | 5    | 2.8  | 4.3  | V/ns  |

**Note:** \*PCI Local Bus Specification, Version 2.1, Section 4.2.1.2.

**Figure 33 • 42MX SRAM Asynchronous Read Operation—Type 2 (Write Address Controlled)**

### 3.10.7 Predictable Performance: Tight Delay Distributions

Propagation delay between logic modules depends on the resistive and capacitive loading of the routing tracks, the interconnect elements, and the module inputs being driven. Propagation delay increases as the length of routing tracks, the number of interconnect elements, or the number of inputs increases.

From a design perspective, the propagation delay can be statistically correlated or modeled by the fanout (number of loads) driven by a module. Higher fanout usually requires some paths to have longer routing tracks.

The MX FPGAs deliver a tight fanout delay distribution, which is achieved in two ways: by decreasing the delay of the interconnect elements and by decreasing the number of interconnect elements per path.

Microsemi's patented antifuse offers a very low resistive/capacitive interconnect. The antifuses, fabricated in 0.45  $\mu\text{m}$  lithography, offer nominal levels of 100  $\Omega$  resistance and 7.0 fF capacitance per antifuse.

MX fanout distribution is also tight due to the low number of antifuses required for each interconnect path. The proprietary architecture limits the number of antifuses per path to a maximum of four, with 90 percent of interconnects using only two antifuses.

## 3.11 Timing Characteristics

Device timing characteristics fall into three categories: family-dependent, device-dependent, and design-dependent. The input and output buffer characteristics are common to all MX devices. Internal routing delays are device-dependent; actual delays are not determined until after place-and-route of the user's design is complete. Delay values may then be determined by using the Designer software utility or by performing simulation with post-layout delays.

### 3.11.1 Critical Nets and Typical Nets

Propagation delays are expressed only for typical nets, which are used for initial design performance evaluation. Critical net delays can then be applied to the most timing critical paths. Critical nets are determined by net property assignment in Microsemi's Designer software prior to placement and routing. Up to 6% of the nets in a design may be designated as critical.

### 3.11.2 Long Tracks

Some nets in the design use long tracks, which are special routing resources that span multiple rows, columns, or modules. Long tracks employ three and sometimes four antifuse connections, which increase capacitance and resistance, resulting in longer net delays for macros connected to long tracks. Typically, up to 6 percent of nets in a fully utilized device require long tracks. Long tracks add

**Table 36 • A40MX04 Timing Characteristics (Nominal 5.0 V Operation) (continued)(Worst-Case Commercial Conditions, VCC = 4.75 V, T<sub>J</sub> = 70°C)**

| Parameter / Description                |                      | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------|----------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                        |                      | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| CMOS Output Module Timing <sup>1</sup> |                      |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                       | Data-to-Pad HIGH     |          | 3.9  |          | 4.5  |          | 5.1  |           | 6.05 |          | 8.5  | ns    |
| t <sub>DHL</sub>                       | Data-to-Pad LOW      |          | 3.4  |          | 3.9  |          | 4.4  |           | 5.2  |          | 7.3  | ns    |
| t <sub>ENZH</sub>                      | Enable Pad Z to HIGH |          | 3.4  |          | 3.9  |          | 4.4  |           | 5.2  |          | 7.3  | ns    |
| t <sub>ENZL</sub>                      | Enable Pad Z to LOW  |          | 4.9  |          | 5.6  |          | 6.4  |           | 7.5  |          | 10.5 | ns    |
| t <sub>ENHZ</sub>                      | Enable Pad HIGH to Z |          | 7.9  |          | 9.1  |          | 10.4 |           | 12.2 |          | 17.0 | ns    |
| t <sub>ENLZ</sub>                      | Enable Pad LOW to Z  |          | 5.9  |          | 6.8  |          | 7.7  |           | 9.0  |          | 12.6 | ns    |
| d <sub>TLH</sub>                       | Delta LOW to HIGH    |          | 0.03 |          | 0.04 |          | 0.04 |           | 0.05 |          | 0.07 | ns/pF |
| d <sub>THL</sub>                       | Delta HIGH to LOW    |          | 0.02 |          | 0.02 |          | 0.03 |           | 0.03 |          | 0.04 | ns/pF |

1. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
2. Set-up times assume fanout of 3. Further testing information can be obtained from the Timer utility
3. The hold time for the DFME1A macro may be greater than 0 ns. Use the Timer utility from the Designer software to check the hold time for this macro.
4. Delays based on 35 pF loading

**Table 37 • A40MX04 Timing Characteristics (Nominal 3.3 V Operation) (Worst-Case Commercial Conditions, VCC = 3.0 V, T<sub>J</sub> = 70°C)**

| Parameter / Description                            |                                     | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|-------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                                     | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Logic Module Propagation Delays                    |                                     |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>PD1</sub>                                   | Single Module                       |          | 1.7  |          | 2.0  |          | 2.3  |           | 2.7  |          | 3.7  | ns    |
| t <sub>PD2</sub>                                   | Dual-Module Macros                  |          | 3.7  |          | 4.3  |          | 4.9  |           | 5.7  |          | 8.0  | ns    |
| t <sub>CO</sub>                                    | Sequential Clock-to-Q               |          | 1.7  |          | 2.0  |          | 2.3  |           | 2.7  |          | 3.7  | ns    |
| t <sub>GO</sub>                                    | Latch G-to-Q                        |          | 1.7  |          | 2.0  |          | 2.3  |           | 2.7  |          | 3.7  | ns    |
| t <sub>RS</sub>                                    | Flip-Flop (Latch) Reset-to-Q        |          | 1.7  |          | 2.0  |          | 2.3  |           | 2.7  |          | 3.7  | ns    |
| Logic Module Predicted Routing Delays <sup>1</sup> |                                     |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>RD1</sub>                                   | FO = 1 Routing Delay                |          | 1.9  |          | 2.2  |          | 2.5  |           | 3.0  |          | 4.2  | ns    |
| t <sub>RD2</sub>                                   | FO = 2 Routing Delay                |          | 2.7  |          | 3.1  |          | 3.5  |           | 4.1  |          | 5.7  | ns    |
| t <sub>RD3</sub>                                   | FO = 3 Routing Delay                |          | 3.4  |          | 3.9  |          | 4.4  |           | 5.2  |          | 7.3  | ns    |
| t <sub>RD4</sub>                                   | FO = 4 Routing Delay                |          | 4.1  |          | 4.8  |          | 5.4  |           | 6.3  |          | 8.9  | ns    |
| t <sub>RD8</sub>                                   | FO = 8 Routing Delay                |          | 7.1  |          | 8.1  |          | 9.2  |           | 10.9 |          | 15.2 | ns    |
| Logic Module Sequential Timing <sup>2</sup>        |                                     |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>SUD</sub>                                   | Flip-Flop (Latch) Data Input Set-Up |          | 4.3  |          | 5.0  |          | 5.6  |           | 6.6  |          | 9.2  | ns    |
| t <sub>HD</sub> <sup>3</sup>                       | Flip-Flop (Latch) Data Input Hold   | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>SUENA</sub>                                 | Flip-Flop (Latch) Enable Set-Up     |          | 4.3  |          | 5.0  |          | 5.6  |           | 6.6  |          | 9.2  | ns    |
| t <sub>HENA</sub>                                  | Flip-Flop (Latch) Enable Hold       | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |

**Table 37 • A40MX04 Timing Characteristics (Nominal 3.3 V Operation) (continued)(Worst-Case Commercial Conditions, VCC = 3.0 V, T<sub>J</sub> = 70°C)**

| Parameter / Description                            |                          |                     | –3 Speed   |      | –2 Speed   |      | –1 Speed   |      | Std Speed    |      | –F Speed     |      | Units |
|----------------------------------------------------|--------------------------|---------------------|------------|------|------------|------|------------|------|--------------|------|--------------|------|-------|
|                                                    |                          |                     | Min.       | Max. | Min.       | Max. | Min.       | Max. | Min.         | Max. | Min.         | Max. |       |
| Input Module Predicted Routing Delays <sup>1</sup> |                          |                     |            |      |            |      |            |      |              |      |              |      |       |
| t <sub>IRD1</sub>                                  | FO = 1 Routing Delay     |                     | 2.9        |      | 3.3        |      | 3.8        |      | 4.5          |      | 6.3          |      | ns    |
| t <sub>IRD2</sub>                                  | FO = 2 Routing Delay     |                     | 3.6        |      | 4.2        |      | 4.8        |      | 5.6          |      | 7.8          |      | ns    |
| t <sub>IRD3</sub>                                  | FO = 3 Routing Delay     |                     | 4.4        |      | 5.0        |      | 5.7        |      | 6.7          |      | 9.4          |      | ns    |
| t <sub>IRD4</sub>                                  | FO = 4 Routing Delay     |                     | 5.1        |      | 5.9        |      | 6.7        |      | 7.8          |      | 11.0         |      | ns    |
| t <sub>IRD8</sub>                                  | FO = 8 Routing Delay     |                     | 8.0        |      | 9.3        |      | 10.5       |      | 12.4         |      | 17.2         |      | ns    |
| Global Clock Network                               |                          |                     |            |      |            |      |            |      |              |      |              |      |       |
| t <sub>CKH</sub>                                   | Input LOW to HIGH        | FO = 16<br>FO = 128 | 6.4<br>6.4 |      | 7.4<br>7.4 |      | 8.4<br>8.4 |      | 9.9<br>9.9   |      | 13.8<br>13.8 |      | ns    |
| t <sub>CKL</sub>                                   | Input HIGH to LOW        | FO = 16<br>FO = 128 | 6.8<br>6.8 |      | 7.8<br>7.8 |      | 8.9<br>8.9 |      | 10.4<br>10.4 |      | 14.6<br>14.6 |      | ns    |
| t <sub>PWH</sub>                                   | Minimum Pulse Width HIGH | FO = 16<br>FO = 128 | 3.1<br>3.3 |      | 3.6<br>3.8 |      | 4.1<br>4.3 |      | 4.8<br>5.1   |      | 6.7<br>7.1   |      | ns    |
| t <sub>PWL</sub>                                   | Minimum Pulse Width LOW  | FO = 16<br>FO = 128 | 3.1<br>3.3 |      | 3.6<br>3.8 |      | 4.1<br>4.3 |      | 4.8<br>5.1   |      | 6.7<br>7.1   |      | ns    |
| t <sub>CKSW</sub>                                  | Maximum Skew             | FO = 16<br>FO = 128 | 0.6<br>0.8 |      | 0.6<br>0.9 |      | 0.7<br>1.0 |      | 0.8<br>1.2   |      | 1.2<br>1.6   |      | ns    |
| t <sub>P</sub>                                     | Minimum Period           | FO = 16<br>FO = 128 | 6.5<br>6.8 |      | 7.5<br>7.8 |      | 8.5<br>8.9 |      | 10.1<br>10.4 |      | 14.1<br>14.6 |      | ns    |
| f <sub>MAX</sub>                                   | Maximum Frequency        | FO = 16<br>FO = 128 | 113<br>109 |      | 105<br>101 |      | 96<br>92   |      | 83<br>80     |      | 50<br>48     |      | MHz   |
| TTL Output Module Timing <sup>4</sup>              |                          |                     |            |      |            |      |            |      |              |      |              |      |       |
| t <sub>DLH</sub>                                   | Data-to-Pad HIGH         |                     | 4.7        |      | 5.4        |      | 6.1        |      | 7.2          |      | 10.0         |      | ns    |
| t <sub>DHL</sub>                                   | Data-to-Pad LOW          |                     | 5.6        |      | 6.4        |      | 7.3        |      | 8.6          |      | 12.0         |      | ns    |
| t <sub>ENZH</sub>                                  | Enable Pad Z to HIGH     |                     | 5.2        |      | 6.0        |      | 6.9        |      | 8.1          |      | 11.3         |      | ns    |
| t <sub>ENZL</sub>                                  | Enable Pad Z to LOW      |                     | 6.6        |      | 7.6        |      | 8.6        |      | 10.1         |      | 14.1         |      | ns    |
| t <sub>ENHZ</sub>                                  | Enable Pad HIGH to Z     |                     | 11.1       |      | 12.8       |      | 14.5       |      | 17.1         |      | 23.9         |      | ns    |
| t <sub>ENLZ</sub>                                  | Enable Pad LOW to Z      |                     | 8.2        |      | 9.5        |      | 10.7       |      | 12.6         |      | 17.7         |      | ns    |
| d <sub>TLH</sub>                                   | Delta LOW to HIGH        |                     | 0.03       |      | 0.03       |      | 0.04       |      | 0.04         |      | 0.06         |      | ns/pF |
| d <sub>THL</sub>                                   | Delta HIGH to LOW        |                     | 0.04       |      | 0.04       |      | 0.05       |      | 0.06         |      | 0.08         |      | ns/pF |

**Table 40 • A42MX16 Timing Characteristics (Nominal 5.0 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)**

| Parameter / Description |                                |          | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|-------------------------|--------------------------------|----------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                         |                                |          | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| t <sub>PWL</sub>        | Minimum Pulse Width<br>LOW     | FO = 32  | 3.2      |      | 3.5      |      | 4.0      |      | 4.7       |      | 6.6      |      | ns    |
|                         |                                | FO = 384 | 3.7      |      | 4.1      |      | 4.6      |      | 5.4       |      | 7.6      |      | ns    |
| t <sub>CKSW</sub>       | Maximum Skew                   | FO = 32  |          | 0.3  |          | 0.4  |          | 0.4  |           | 0.5  |          | 0.7  | ns    |
|                         |                                | FO = 384 |          | 0.3  |          | 0.4  |          | 0.4  |           | 0.5  |          | 0.7  | ns    |
| t <sub>SUEXT</sub>      | Input Latch External<br>Set-Up | FO = 32  | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
|                         |                                | FO = 384 | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>HEXT</sub>       | Input Latch External<br>Hold   | FO = 32  | 2.8      |      | 3.1      |      | 5.5      |      | 4.1       |      | 5.7      |      | ns    |
|                         |                                | FO = 384 | 3.2      |      | 3.5      |      | 4.0      |      | 4.7       |      | 6.6      |      | ns    |
| t <sub>P</sub>          | Minimum Period                 | FO = 32  | 4.2      |      | 4.67     |      | 5.1      |      | 5.8       |      | 9.7      |      | ns    |
|                         |                                | FO = 384 | 4.6      |      | 5.1      |      | 5.6      |      | 6.4       |      | 10.7     |      | ns    |
| f <sub>MAX</sub>        | Maximum Frequency              | FO = 32  |          | 237  |          | 215  |          | 198  |           | 172  |          | 103  | MHz   |
|                         |                                | FO = 384 |          | 215  |          | 195  |          | 179  |           | 156  |          | 94   | MHz   |

**Table 40 • A42MX16 Timing Characteristics (Nominal 5.0 V Operation) (continued)**(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)

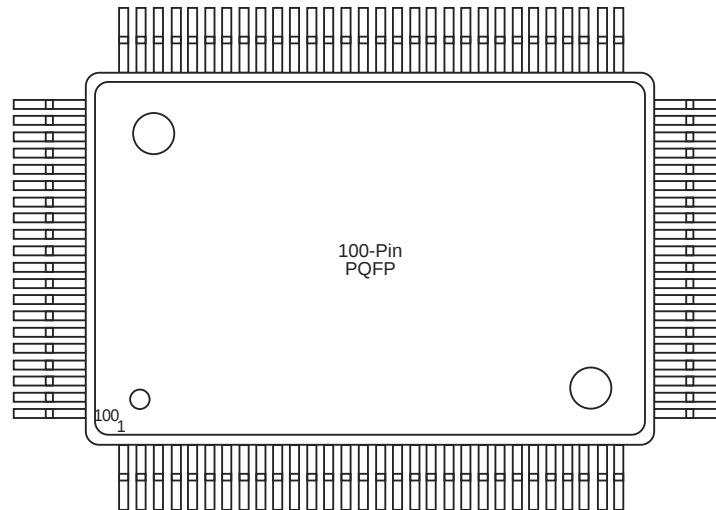
| Parameter / Description               |                                                          | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|---------------------------------------|----------------------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                       |                                                          | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| TTL Output Module Timing <sup>4</sup> |                                                          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                      | Data-to-Pad HIGH                                         | 2.5      |      | 2.8      |      | 3.2      |      | 3.7       |      | 5.2      |      | ns    |
| t <sub>DHL</sub>                      | Data-to-Pad LOW                                          | 3.0      |      | 3.3      |      | 3.7      |      | 4.4       |      | 6.1      |      | ns    |
| t <sub>ENZH</sub>                     | Enable Pad Z to HIGH                                     | 2.7      |      | 3.0      |      | 3.4      |      | 4.0       |      | 5.6      |      | ns    |
| t <sub>ENZL</sub>                     | Enable Pad Z to LOW                                      | 3.0      |      | 3.3      |      | 3.8      |      | 4.4       |      | 6.2      |      | ns    |
| t <sub>ENHZ</sub>                     | Enable Pad HIGH to Z                                     | 5.4      |      | 6.0      |      | 6.8      |      | 8.0       |      | 11.2     |      | ns    |
| t <sub>ENLZ</sub>                     | Enable Pad LOW to Z                                      | 5.0      |      | 5.6      |      | 6.3      |      | 7.4       |      | 10.4     |      | ns    |
| t <sub>GLH</sub>                      | G-to-Pad HIGH                                            | 2.9      |      | 3.2      |      | 3.6      |      | 4.3       |      | 6.0      |      | ns    |
| t <sub>GHL</sub>                      | G-to-Pad LOW                                             | 2.9      |      | 3.2      |      | 3.6      |      | 4.3       |      | 6.0      |      | ns    |
| t <sub>LCO</sub>                      | I/O Latch Clock-to-Out<br>(Pad-to-Pad), 64 Clock Loading | 5.7      |      | 6.3      |      | 7.1      |      | 8.4       |      | 11.9     |      | ns    |
| t <sub>ACO</sub>                      | Array Clock-to-Out<br>(Pad-to-Pad), 64 Clock Loading     | 8.0      |      | 8.9      |      | 10.1     |      | 11.9      |      | 16.7     |      | ns    |
| d <sub>TLH</sub>                      | Capacitive Loading, LOW to HIGH                          | 0.03     |      | 0.03     |      | 0.03     |      | 0.04      |      | 0.06     |      | ns/pF |
| d <sub>THL</sub>                      | Capacitive Loading, HIGH to LOW                          | 0.04     |      | 0.04     |      | 0.04     |      | 0.05      |      | 0.07     |      | ns/pF |

**Table 49 • PL84**

| <b>PL84</b>       |                         |                         |                         |                         |
|-------------------|-------------------------|-------------------------|-------------------------|-------------------------|
| <b>Pin Number</b> | <b>A40MX04 Function</b> | <b>A42MX09 Function</b> | <b>A42MX16 Function</b> | <b>A42MX24 Function</b> |
| 47                | I/O                     | I/O                     | I/O                     | WD, I/O                 |
| 48                | I/O                     | I/O                     | I/O                     | I/O                     |
| 49                | I/O                     | GND                     | GND                     | GND                     |
| 50                | I/O                     | I/O                     | I/O                     | WD, I/O                 |
| 51                | I/O                     | I/O                     | I/O                     | WD, I/O                 |
| 52                | I/O                     | SDO, I/O                | SDO, I/O                | SDO, TDO, I/O           |
| 53                | I/O                     | I/O                     | I/O                     | I/O                     |
| 54                | I/O                     | I/O                     | I/O                     | I/O                     |
| 55                | I/O                     | I/O                     | I/O                     | I/O                     |
| 56                | I/O                     | I/O                     | I/O                     | I/O                     |
| 57                | I/O                     | I/O                     | I/O                     | I/O                     |
| 58                | I/O                     | I/O                     | I/O                     | I/O                     |
| 59                | I/O                     | I/O                     | I/O                     | I/O                     |
| 60                | GND                     | I/O                     | I/O                     | I/O                     |
| 61                | GND                     | I/O                     | I/O                     | I/O                     |
| 62                | I/O                     | I/O                     | I/O                     | TCK, I/O                |
| 63                | I/O                     | LP                      | LP                      | LP                      |
| 64                | CLK, I/O                | VCCA                    | VCCA                    | VCCA                    |
| 65                | I/O                     | VCCI                    | VCCI                    | VCCI                    |
| 66                | MODE                    | I/O                     | I/O                     | I/O                     |
| 67                | VCC                     | I/O                     | I/O                     | I/O                     |
| 68                | VCC                     | I/O                     | I/O                     | I/O                     |
| 69                | I/O                     | I/O                     | I/O                     | I/O                     |
| 70                | I/O                     | GND                     | GND                     | GND                     |
| 71                | I/O                     | I/O                     | I/O                     | I/O                     |
| 72                | SDI, I/O                | I/O                     | I/O                     | I/O                     |
| 73                | DCLK, I/O               | I/O                     | I/O                     | I/O                     |
| 74                | PRA, I/O                | I/O                     | I/O                     | I/O                     |
| 75                | PRB, I/O                | I/O                     | I/O                     | I/O                     |
| 76                | I/O                     | SDI, I/O                | SDI, I/O                | SDI, I/O                |
| 77                | I/O                     | I/O                     | I/O                     | I/O                     |
| 78                | I/O                     | I/O                     | I/O                     | WD, I/O                 |
| 79                | I/O                     | I/O                     | I/O                     | WD, I/O                 |
| 80                | I/O                     | I/O                     | I/O                     | WD, I/O                 |
| 81                | I/O                     | PRA, I/O                | PRA, I/O                | PRA, I/O                |
| 82                | GND                     | I/O                     | I/O                     | I/O                     |
| 83                | I/O                     | CLKA, I/O               | CLKA, I/O               | CLKA, I/O               |

**Table 49 • PL84**

| <b>PL84</b>       |                         |                         |                         |                         |
|-------------------|-------------------------|-------------------------|-------------------------|-------------------------|
| <b>Pin Number</b> | <b>A40MX04 Function</b> | <b>A42MX09 Function</b> | <b>A42MX16 Function</b> | <b>A42MX24 Function</b> |
| 84                | I/O                     | VCCA                    | VCCA                    | VCCA                    |

**Figure 41 • PQ100****Table 50 • PQ 100**

| <b>PQ100</b>      |                         |                         |                         |                         |
|-------------------|-------------------------|-------------------------|-------------------------|-------------------------|
| <b>Pin Number</b> | <b>A40MX02 Function</b> | <b>A40MX04 Function</b> | <b>A42MX09 Function</b> | <b>A42MX16 Function</b> |
| 1                 | NC                      | NC                      | I/O                     | I/O                     |
| 2                 | NC                      | NC                      | DCLK, I/O               | DCLK, I/O               |
| 3                 | NC                      | NC                      | I/O                     | I/O                     |
| 4                 | NC                      | NC                      | MODE                    | MODE                    |
| 5                 | NC                      | NC                      | I/O                     | I/O                     |
| 6                 | PRB, I/O                | PRB, I/O                | I/O                     | I/O                     |
| 7                 | I/O                     | I/O                     | I/O                     | I/O                     |
| 8                 | I/O                     | I/O                     | I/O                     | I/O                     |
| 9                 | I/O                     | I/O                     | GND                     | GND                     |
| 10                | I/O                     | I/O                     | I/O                     | I/O                     |
| 11                | I/O                     | I/O                     | I/O                     | I/O                     |
| 12                | I/O                     | I/O                     | I/O                     | I/O                     |
| 13                | GND                     | GND                     | I/O                     | I/O                     |
| 14                | I/O                     | I/O                     | I/O                     | I/O                     |
| 15                | I/O                     | I/O                     | I/O                     | I/O                     |
| 16                | I/O                     | I/O                     | VCCA                    | VCCA                    |
| 17                | I/O                     | I/O                     | VCCI                    | VCCA                    |
| 18                | I/O                     | I/O                     | I/O                     | I/O                     |

Figure 42 • PQ144

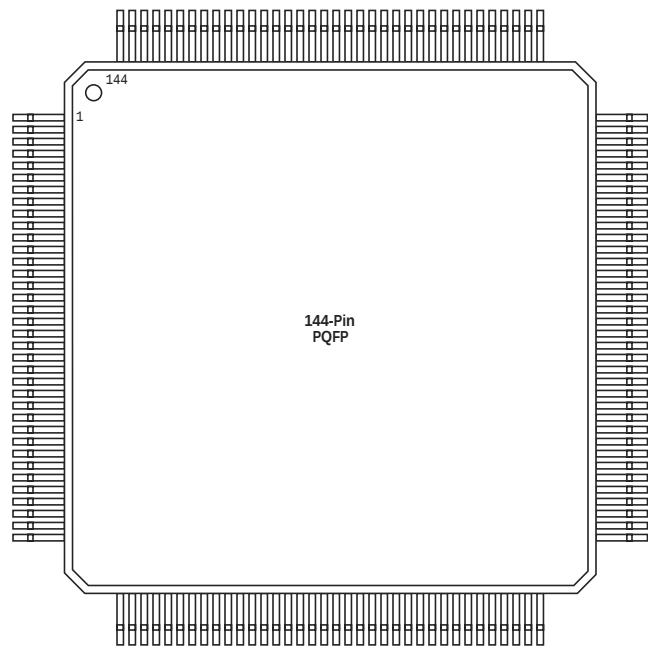


Table 51 • PQ144

| PQ144      |                  |
|------------|------------------|
| Pin Number | A42MX09 Function |
| 1          | I/O              |
| 2          | MODE             |
| 3          | I/O              |
| 4          | I/O              |
| 5          | I/O              |

Table 54 • PQ240

| PQ240      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| 237        | GND              |
| 238        | MODE             |
| 239        | VCCA             |
| 240        | GND              |

Figure 46 • VQ80

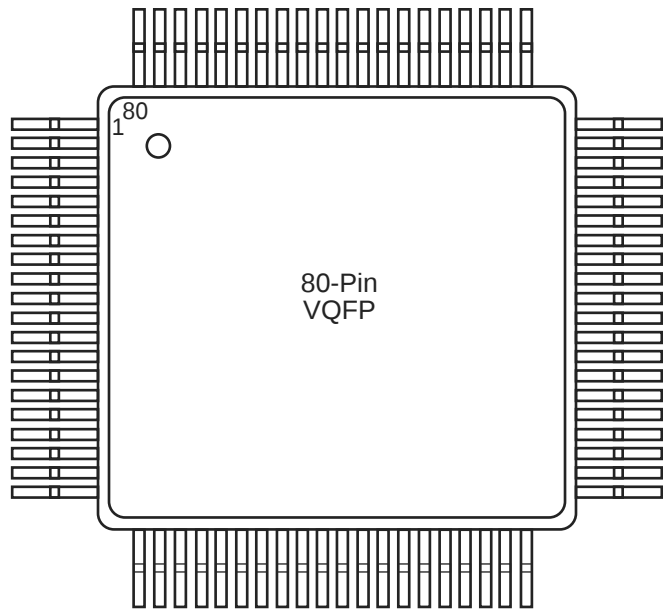


Table 55 • VQ80

| VQ80       |                  |                  |
|------------|------------------|------------------|
| Pin Number | A40MX02 Function | A40MX04 Function |
| 1          | I/O              | I/O              |
| 2          | NC               | I/O              |
| 3          | NC               | I/O              |
| 4          | NC               | I/O              |
| 5          | I/O              | I/O              |
| 6          | I/O              | I/O              |
| 7          | GND              | GND              |
| 8          | I/O              | I/O              |
| 9          | I/O              | I/O              |
| 10         | I/O              | I/O              |
| 11         | I/O              | I/O              |
| 12         | I/O              | I/O              |

**Table 55 • VQ80**

| <b>VQ80</b>       |                             |                             |
|-------------------|-----------------------------|-----------------------------|
| <b>Pin Number</b> | <b>A40MX02<br/>Function</b> | <b>A40MX04<br/>Function</b> |
| 13                | VCC                         | VCC                         |
| 14                | I/O                         | I/O                         |
| 15                | I/O                         | I/O                         |
| 16                | I/O                         | I/O                         |
| 17                | NC                          | I/O                         |
| 18                | NC                          | I/O                         |
| 19                | NC                          | I/O                         |
| 20                | VCC                         | VCC                         |
| 21                | I/O                         | I/O                         |
| 22                | I/O                         | I/O                         |
| 23                | I/O                         | I/O                         |
| 24                | I/O                         | I/O                         |
| 25                | I/O                         | I/O                         |
| 26                | I/O                         | I/O                         |
| 27                | GND                         | GND                         |
| 28                | I/O                         | I/O                         |
| 29                | I/O                         | I/O                         |
| 30                | I/O                         | I/O                         |
| 31                | I/O                         | I/O                         |
| 32                | I/O                         | I/O                         |
| 33                | VCC                         | VCC                         |
| 34                | I/O                         | I/O                         |
| 35                | I/O                         | I/O                         |
| 36                | I/O                         | I/O                         |
| 37                | I/O                         | I/O                         |
| 38                | I/O                         | I/O                         |
| 39                | I/O                         | I/O                         |
| 40                | I/O                         | I/O                         |
| 41                | NC                          | I/O                         |
| 42                | NC                          | I/O                         |
| 43                | NC                          | I/O                         |
| 44                | I/O                         | I/O                         |
| 45                | I/O                         | I/O                         |
| 46                | I/O                         | I/O                         |
| 47                | GND                         | GND                         |
| 48                | I/O                         | I/O                         |

**Table 57 • TQ176**

| <b>TQ176</b>      |                         |                         |                         |
|-------------------|-------------------------|-------------------------|-------------------------|
| <b>Pin Number</b> | <b>A42MX09 Function</b> | <b>A42MX16 Function</b> | <b>A42MX24 Function</b> |
| 10                | NC                      | I/O                     | I/O                     |
| 11                | NC                      | I/O                     | I/O                     |
| 12                | I/O                     | I/O                     | I/O                     |
| 13                | NC                      | VCCA                    | VCCA                    |
| 14                | I/O                     | I/O                     | I/O                     |
| 15                | I/O                     | I/O                     | I/O                     |
| 16                | I/O                     | I/O                     | I/O                     |
| 17                | I/O                     | I/O                     | I/O                     |
| 18                | GND                     | GND                     | GND                     |
| 19                | NC                      | I/O                     | I/O                     |
| 20                | NC                      | I/O                     | I/O                     |
| 21                | I/O                     | I/O                     | I/O                     |
| 22                | NC                      | I/O                     | I/O                     |
| 23                | GND                     | GND                     | GND                     |
| 24                | NC                      | VCCI                    | VCCI                    |
| 25                | VCCA                    | VCCA                    | VCCA                    |
| 26                | NC                      | I/O                     | I/O                     |
| 27                | NC                      | I/O                     | I/O                     |
| 28                | VCCI                    | VCCA                    | VCCA                    |
| 29                | NC                      | I/O                     | I/O                     |
| 30                | I/O                     | I/O                     | I/O                     |
| 31                | I/O                     | I/O                     | I/O                     |
| 32                | I/O                     | I/O                     | I/O                     |
| 33                | NC                      | NC                      | I/O                     |
| 34                | I/O                     | I/O                     | I/O                     |
| 35                | I/O                     | I/O                     | I/O                     |
| 36                | I/O                     | I/O                     | I/O                     |
| 37                | NC                      | I/O                     | I/O                     |
| 38                | NC                      | NC                      | I/O                     |
| 39                | I/O                     | I/O                     | I/O                     |
| 40                | I/O                     | I/O                     | I/O                     |
| 41                | I/O                     | I/O                     | I/O                     |
| 42                | I/O                     | I/O                     | I/O                     |
| 43                | I/O                     | I/O                     | I/O                     |
| 44                | I/O                     | I/O                     | I/O                     |
| 45                | GND                     | GND                     | GND                     |
| 46                | I/O                     | I/O                     | TMS, I/O                |

**Table 59 • CQ256**

| <b>CQ256</b>      |                         |
|-------------------|-------------------------|
| <b>Pin Number</b> | <b>A42MX36 Function</b> |
| 207               | I/O                     |
| 208               | I/O                     |
| 209               | QCLKC, I/O              |
| 210               | I/O                     |
| 211               | WD, I/O                 |
| 212               | WD, I/O                 |
| 213               | I/O                     |
| 214               | I/O                     |
| 215               | WD, I/O                 |
| 216               | WD, I/O                 |
| 217               | I/O                     |
| 218               | PRB, I/O                |
| 219               | I/O                     |
| 220               | CLKB, I/O               |
| 221               | I/O                     |
| 222               | GND                     |
| 223               | GND                     |
| 224               | VCCA                    |
| 225               | VCCI                    |
| 226               | I/O                     |
| 227               | CLKA, I/O               |
| 228               | I/O                     |
| 229               | PRA, I/O                |
| 230               | I/O                     |
| 231               | I/O                     |
| 232               | WD, I/O                 |
| 233               | WD, I/O                 |
| 234               | I/O                     |
| 235               | I/O                     |
| 236               | I/O                     |
| 237               | I/O                     |
| 238               | I/O                     |
| 239               | I/O                     |
| 240               | QCLKD, I/O              |
| 241               | I/O                     |
| 242               | WD, I/O                 |
| 243               | GND                     |

**Table 60 • BG272**

| <b>BG272</b>      |                         |
|-------------------|-------------------------|
| <b>Pin Number</b> | <b>A42MX36 Function</b> |
| A6                | I/O                     |
| A7                | WD, I/O                 |
| A8                | WD, I/O                 |
| A9                | I/O                     |
| A10               | I/O                     |
| A11               | CLKA                    |
| A12               | I/O                     |
| A13               | I/O                     |
| A14               | I/O                     |
| A15               | I/O                     |
| A16               | WD, I/O                 |
| A17               | I/O                     |
| A18               | I/O                     |
| A19               | GND                     |
| A20               | GND                     |
| B1                | GND                     |
| B2                | GND                     |
| B3                | DCLK, I/O               |
| B4                | I/O                     |
| B5                | I/O                     |
| B6                | I/O                     |
| B7                | WD, I/O                 |
| B8                | I/O                     |
| B9                | PRB, I/O                |
| B10               | I/O                     |
| B11               | I/O                     |
| B12               | WD, I/O                 |
| B13               | I/O                     |
| B14               | I/O                     |
| B15               | WD, I/O                 |
| B16               | I/O                     |
| B17               | WD, I/O                 |
| B18               | I/O                     |
| B19               | GND                     |
| B20               | GND                     |
| C1                | I/O                     |
| C2                | MODE                    |